

VMDSEMI

**VUSG002R780NA**

**Datasheet**

## General Description

## Symbol

$V_{(BR)DSS}$	$R_{DS(ON)_{max}}$	$I_D$
20V	78mΩ@4.5V	2.1A
	105mΩ@2.5V	

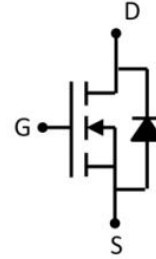
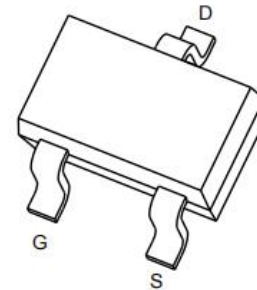


Figure 1 Symbol of VUSG002R780NA

## Features

- Excellent  $R_{DS(on)}$  and Low Gate Charge
- Trench FET Power MOSFET

## Package Type



## SOT-323

Figure 2 Package Type of VUSG002R780NA

## Application

- DC/DC Converter
- Load Switch for Portable Devices
- Small Portable Electronics

## Ordering Information

Product Name	Package
VUSG002R780NA	SOT-323

**Absolute Maximum Ratings** ( $T_A=25\text{ }^\circ\text{C}$ , unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DSS}$	20	V
Gate-Source Voltage	$V_{GSS}$	$\pm 8$	V
Continuous Drain Current <sup>Note1</sup>	$I_D$	2.1	A
Pulsed Drain Current <sup>Note3</sup>	$I_{DM}$	6.3	A
Total Power Dissipation <sup>Note4</sup>	$P_D$	0.2	W
Junction Temperature	$T_J$	150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$	-55 to 150	$^\circ\text{C}$

**Thermal Resistance**

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Ambient <sup>Note2</sup>	$R_{\theta JA}$		819		$^\circ\text{C/W}$

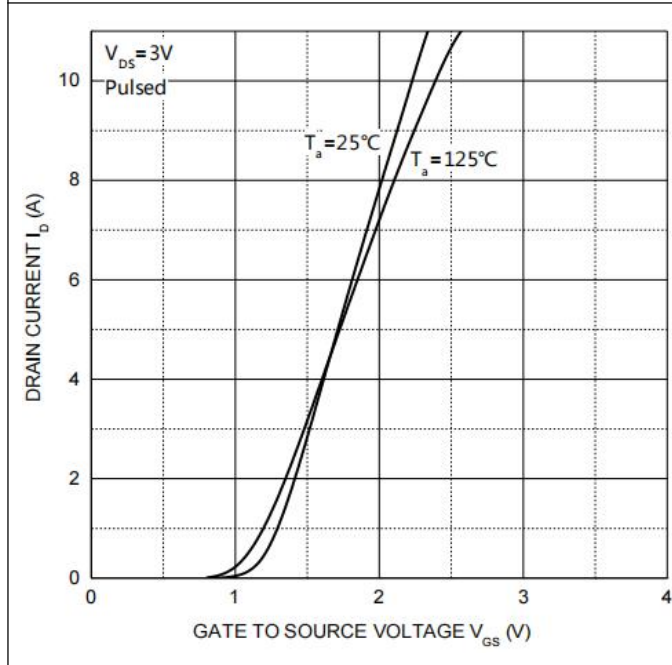
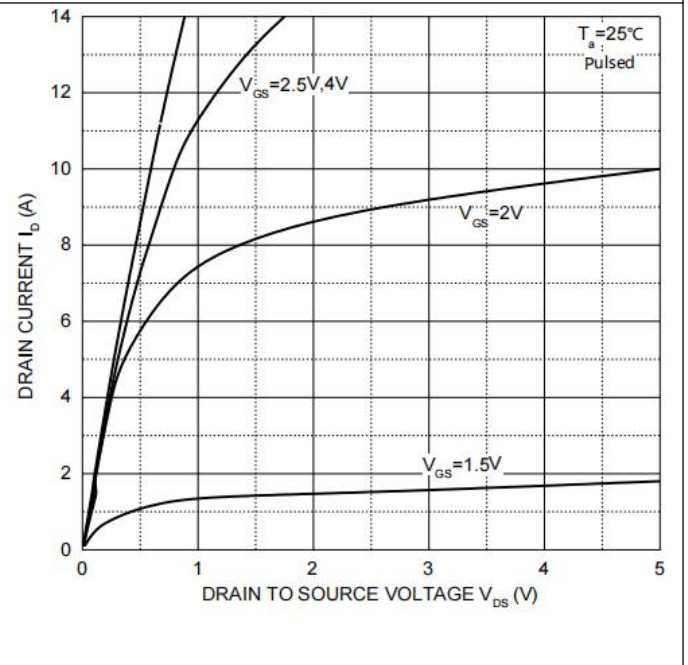
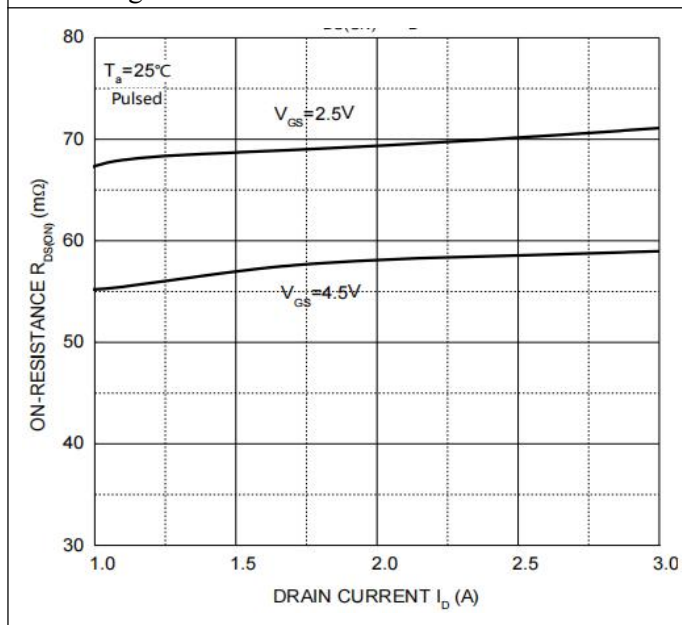
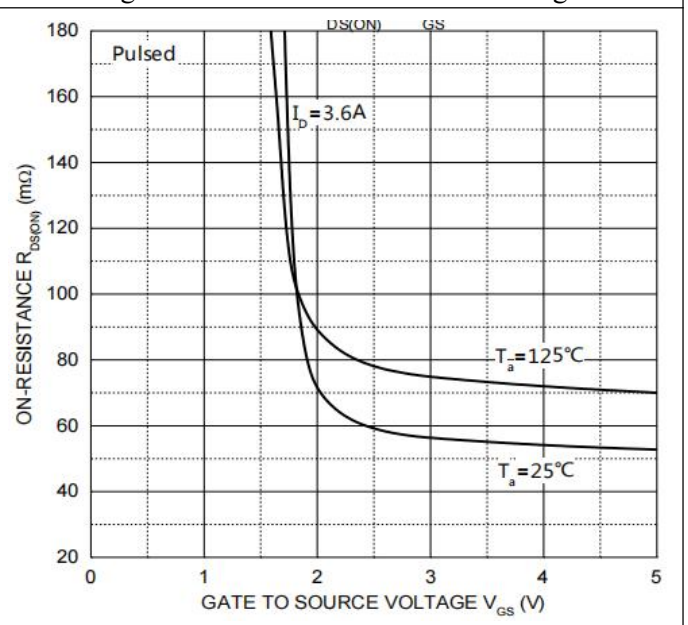
**Electrical Characteristics** ( $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise specified)

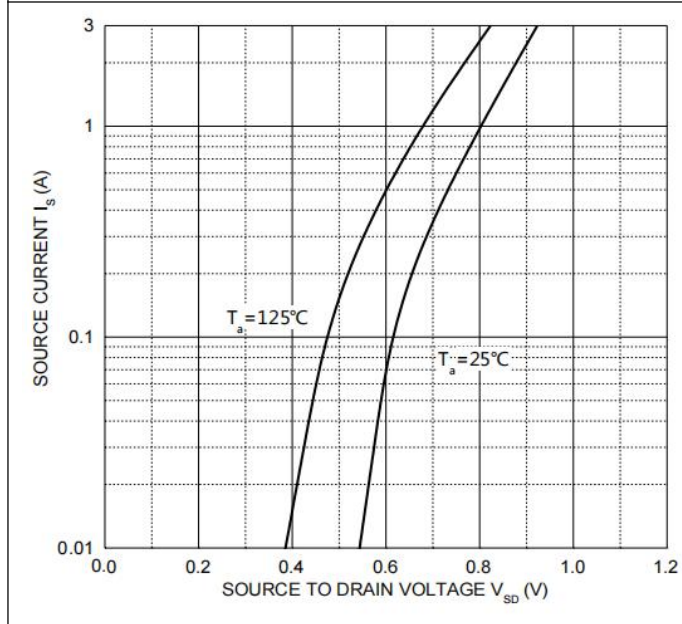
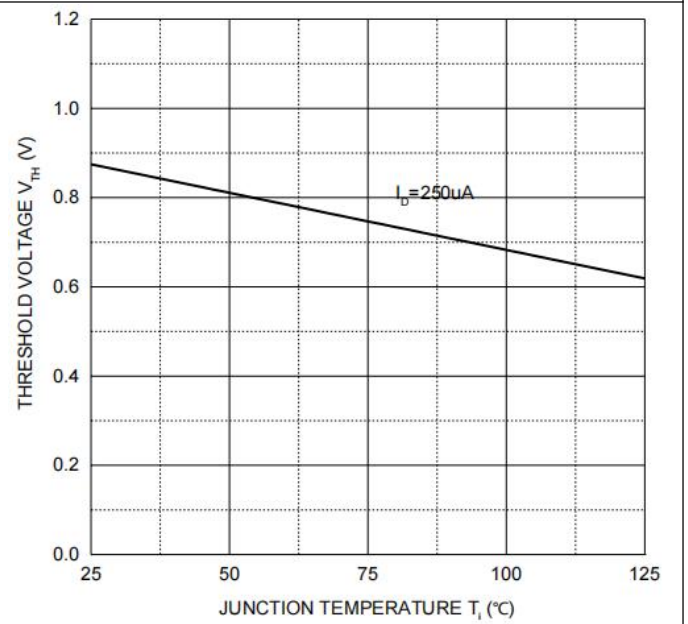
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Statistic Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	20			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=20V, V_{GS}=0V$			1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS} = \pm 8V, V_{DS}=0V$			$\pm 0.1$	$\mu A$
Gate Threshold Voltage <sup>Note3</sup>	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.65	0.95	1.2	V
Drain-source on-resistance <sup>Note3</sup>	$R_{DS(on)}$	$V_{GS}=4.5V, I_D=3.6A$		59	78	
		$V_{GS}=2.5V, I_D=3.1A$		70	105	
Forward transconductance <sup>Note3</sup>	$g_{FS}$	$V_{DS}=5V, I_D=3.6A$	8			S
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{ISS}$	$V_{DS}=10V$		305		pF
Output Capacitance	$C_{OSS}$	$V_{GS}=0V$		122		pF
Reverse Transfer Capacitance	$C_{RSS}$	$f=1MHz$		83		pF
Total gate charge	$Q_g$	$V_{DS}=10V$		2	12	nC
Gate-source charge	$Q_{gs}$	$V_{GS}=4.5V$		0.67		nC
Gate-drain charge	$Q_{gd}$	$I_D=3.6A$		1.3		nC
<b>Switching Parameters</b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=10V$		8	16	ns
Turn-on Rise Time	$t_r$	$V_{GEN}=4.5V$		56	79	
Turn-off Delay Time	$t_{d(off)}$	$R_L=5.5\Omega$		17	65	
Turn-off Fall Time	$t_f$	$R_{GEN}=6\Omega, I_D=3.6A$		11	26	
<b>Diode Characteristics</b>						
Diode Forward Voltage <sup>Note3</sup>	$V_{SD}$	$V_{GS}=0V, I_S=0.94A$			1.2	V

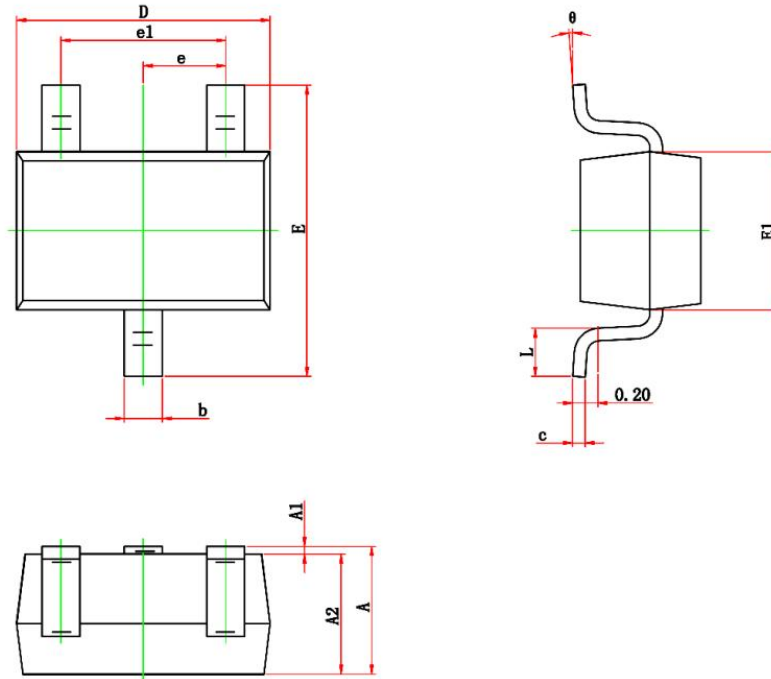
Notes :

- 1.The maximum current rating is limited by package.
- 2.Device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .
- 3.Pulse Test : Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
- 4.The power dissipation  $P_D$  is limited by  $T_{J(MAX)} = 150^\circ\text{C}$ .

## Typical Performance Characteristics

**Figure 3: Transfer Characteristics**

**Figure 4: Output Characteristics**

**Figure 5: On-Resistance vs. Drain Current**

**Figure 6: On-Resistance vs. Gate Voltage**


**Figure 7: Body Diode Characteristics**

**Figure 8: Threshold Voltage**


**Mechanical Dimensions:**
**SOT-323 Package Information**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.050	0.150	0.002	0.006
D	1.900	2.200	0.075	0.087
E	2.000	2.450	0.079	0.096
E1	1.150	1.350	0.045	0.053
e	0.650TYP.		0.026TYP.	
e1	1.200	1.400	0.047	0.055
L	0.200	0.460	0.008	0.018
θ	0°	8°	0°	8°

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